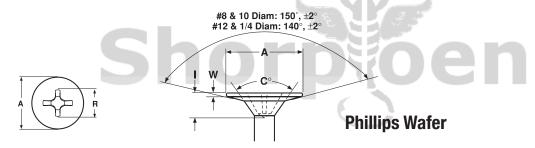
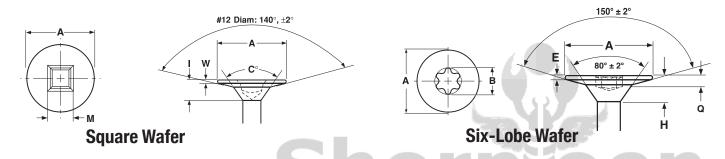
HEAD DIMENSIONS

Wafer: Phillips, Square & Six-Lobe Recess



Wafer Phillips Head for Self-Drilling Screws										
Nominal Size	Α		R		I	w		Bottom	Phillips Driver Size	
	Head Diameter		Recess Diameter		Recess Depth	Wafer Thickness		Countersink Angle		
	Max.	Min.	Max	Min	Ref.	Max	Min	± 2°		
8	.380	.359	.189	.176	.255	.035	.025	50°	2	
10	.516	.441	.204	.190	.322	.040	.031	80°	2	
12	.552	.511	.268	.254	.377	.040	.031	70°	3	
1/4	.620	.580	.282	.267	.160	.042	.033	70°	3	

NOTE: There is no single standard for Wafer head dimensions. These values are offered as a guide; deviations from these specifications may occur



Wafer Square Recess Head for Self-Drilling Screws										
Nominal Size	Α		М	ı		w		С		
	Head Diameter		Recess Width	Recess Depth		Wafer Thickness		Bottom Countersink Angle	Phillips Driver Size	
	Max.	Min.	Ref	Max	Min	Max	Min	± 2°		
12	.551	.512	.133	.095	.080	.039	.031	70°	3	

NOTE: There is no single standard for Wafer head dimensions. These values are offered as a guide; deviations from these specifications may occur

Wafer Six-Lobe Head for Self-Drilling Screws										
Nominal Size	A		В Н		,					
	Head Diameter		Recess Diameter	Total Head Height	Wafer Thickness		Six-Lobe Recess Size			
	Max.	Min.	Ref	Ref.	Max	Min				
10	.516	.441	.155	.150	.040	.031	TX-20			

NOTE: There is no single standard for Wafer head dimensions. These values are offered as a guide; deviations from these specifications may occur